

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE

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**Field Device Integration (FDI) –  
Part 109-1: Profiles – HART® and WirelessHART®**

**Intégration des appareils de terrain (FDI) –  
Partie 109-1: Profils – HART® et WirelessHART®**





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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## FIELD DEVICE INTEGRATION (FDI) –

**Part 109-1: Profiles –  
HART® and WirelessHART®**

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International Standard IEC 62769-109-1 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

The text of this standard is based on the following documents:

CDV	Report on voting
65E/356/CDV	65E/419/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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## FIELD DEVICE INTEGRATION (FDI) –

### Part 109-1: Profiles – HART® and WirelessHART®

#### 1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for IEC 61784-1\_CP 9/1 (HART®)<sup>1</sup> and IEC 61784-1\_CP 9/2 (WirelessHART®)<sup>1</sup>.

#### 2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62541-100, *OPC unified architecture – Part 100: Device Interface*

IEC 62769-4:2015, *Field Device Integration (FDI) – Part 4: FDI Packages*

NOTE IEC 62769-4 is technically identical to FDI-2024.

IEC 62769-5, *Field Device Integration (FDI) – Part 5: FDI Information Model*

NOTE IEC 62769-5 is technically identical to FDI-2025.

IEC 62769-7, *Field Device Integration (FDI) – Part 7: Communication Devices*

NOTE IEC 62769-7 is technically identical to FDI-2027.

#### 3 Terms, definitions, abbreviated terms and acronyms

##### 3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62541-100, IEC 62769-4, IEC 62769-5 and IEC 62769-7 apply.

##### 3.2 Abbreviated terms and acronyms

For the purposes of this document, the following abbreviations apply:

CP	Communication profile (see IEC 61784-1 or IEC 61784-2)
CPF	Communication profile family (see IEC 61784-1 or IEC 61784-2)
EDD	Electronic Device Description (see IEC 61804)
EDDL	Electronic Device Description Language (see IEC 61804)
FDI	Field Device Integration

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<sup>1</sup> HART and WirelessHART are the trade names of the non-profit consortium HART Communication Foundation, Austin, Texas, USA. This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance does not require use of the trade names. Use of the trade names requires permission of the trade name holder.